

PRODUCTS GUIDE



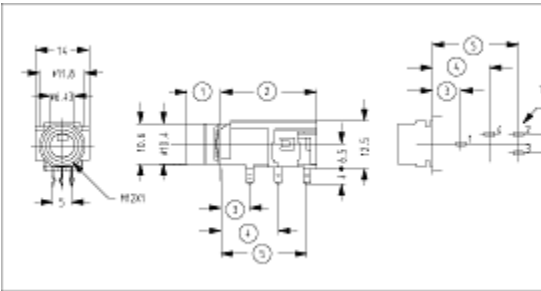
PHONE JACKS

SPECIFICATIONS

Contact Resistance : 30mΩ max.
Insulation Resistance : 100MΩ min. at DC 500V
Insulation Withstanding Voltage : 500V AC for one minute.

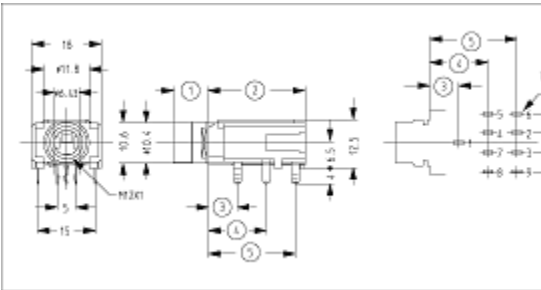
For more information, please ask for a detail

6.5 DIA PJ3 SERIES



RA TYPE								2B	3A	3Z	Type of
Type	1	2	3	4	5	Sleeve	Plating				
A	9	25	7.5	15	22.5	Mold		YKB21-5012	YKB21-5010	YKB21-5074	
						Metal	Ni	YKB21-5011	YKB21-5009	YKB21-5166	
							Au	YKB21-5176	YKB21-5138	YKB21-5248	
B	9	25	7.5	15	22.5	Mold		-	YKB21-5261	YKB21-5262	
						Metal	Ni	-	YKB21-5265	YKB21-5288	
							Au	-	YKB21-5266	YKB21-5267	
	11.5	22.5	5	12.5	20	Mold		-	YKB21-5806	YKB21-5829	
						Metal	Ni	-	YKB21-5805	YKB21-5808	
							Au	-	YKB21-5807	YKB21-5830	

6.5 DIA PJ9 SERIES

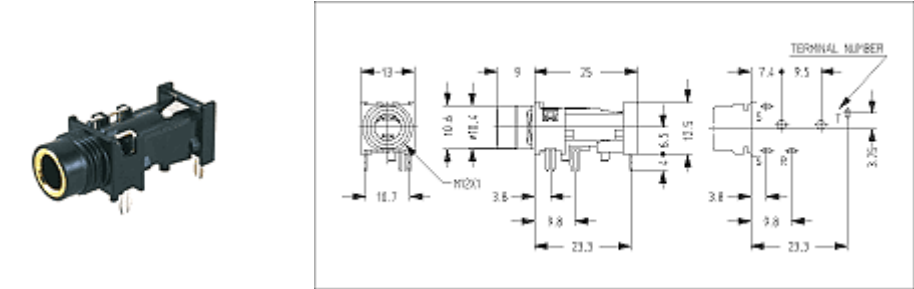


RA TYPE								2D	2E	3C	3E
Type	1	2	3	4	5	Sleeve	Plating				
A	9	25	7.5	15	22.5	Mold		YKB21-5018	YKB21-5076	YKB21-5006	Y
							Ni	YKB21-5017	YKB21-5075	YKB21-5005	Y

						Metal	Au	YKB21-5139	YKB21-5218	YKB21-5153	Y
B	11.5	22.5	5	12.5	20	Mold		YKB21-5818	YKB21-5821	YKB21-5824	Y
						Metal	Ni	YKB21-5817	YKB21-5820	YKB21-5823	Y
							Au	YKB21-5819	YKB21-5822	YKB21-5825	Y

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We offer PJ9 series with boss which prevent the body from b

6.5 DIA PX3 SERIES



RA TYPE							3Z 	
Type	1	2	3	4	5	Sleeve	Plating	
B	9	25	3.8	9.8	23.3	Mold		YKB21-5320
						Metal	Ni	YKB21-5321
							Au	YKB21-5317